MULTI-COM.PL



BEST BST-328 solder paste 50g

Product ID: 22345

Price: **10.00 EUR**

Product weight: **0.30 kg**

Description:

BEST BST-328 solder paste 50g original Sn63 / Pb37 (with lead content) is "liquid tin", used for soldering small and hard-to-reach SMD components and replacing balls on BGA systems. Especially recommended and often used for GSM applications. It is used for BGAP screens, thanks to which we obtain the desired mapping of soldering fields to BGA circuits in GSM applications. The paste is also very well suited for precoating BGA pads with lead tin.

Go to the product

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